DJC Package
22-Lead Plastic DFN (6mm × 3mm)
(Reference LTC DWG # 05-08-1714)

NOTE:
1. DRAWING PROPOSED TO BE MADE VARIATION OF VERSION (WXXX) IN JEDEC PACKAGE OUTLINE M0-229
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON TOP AND BOTTOM OF PACKAGE

RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS

NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED
3. DRAWING IS NOT TO SCALE

R = 0.10 TYP
R = 0.115 TYP

R0.30 TYP OR 0.25mm × 45° CHAMFER

PACKAGE OUTLINE

BOTTOM VIEW—EXPOSED PAD